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Vishay Siliconix

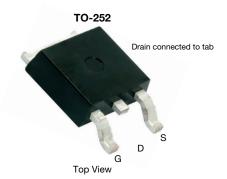
Automotive N-Channel 60 V (D-S) 175 °C MOSFET

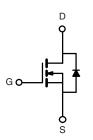
PRODUCT SUMMARY					
V _{DS} (V)	60				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.014				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.017				
I _D (A)	40				
Configuration	Single				
Package	TO-252				

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_q and UIS tested
- AEC-Q101 qualified d
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V_{DS}	60	V		
Gate-Source Voltage	V_{GS}	± 20	V		
Continuous Drain Current	T _C = 25 °C ^a	1	40		
	T _C = 125 °C	- I _D -	29		
Continuous Source Current (Diode Conduc	Is	40	Α		
Pulsed Drain Current ^b	I _{DM}	160			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	32		
Single Pulse Avalanche Energy	L = 0.1 11111	E _{AS}	51	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	75	W	
	T _C = 125 °C		25	VV	
Operating Junction and Storage Temperatu	ire Range	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	60	°C/W	
Junction-to-Case (Drain)		R_{thJC}	2	G/ VV	

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					I.	I.	
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0, I_D = 250 \mu A$		60	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2.0	2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 60 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 60 V, T _J = 125 °C	-	-	50	μΑ
		V _{GS} = 0 V	V _{DS} = 60 V, T _J = 175 °C	-	-	250	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 \text{ V}$	30	-	-	Α
		V _{GS} = 10 V	I _D = 20 A	-	0.011	0.014	
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	-	-	0.024	Ω
Diani-Source Oil-State nesistance ~	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	-	-	0.029	
		V _{GS} = 4.5 V	I _D = 20 A, T _J = 25 °C	-	0.014	0.017	
Forward Transconductance ^a	9fs	V _{DS} = 15 V, I _D = 20 A		-	52	=.	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	1685	2105	pF
Output Capacitance	Coss	$V_{GS} = 0 V$	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	-	305	385	
Reverse Transfer Capacitance	C_{rss}			ı	180	225	
Total Gate Charge ^c	Qg			-	34	51	
Gate-Source Charge ^c	Q_{gs}	V _{GS} = 10 V	$V_{DS} = 30 \text{ V}, I_D = 40 \text{ A}$	1	6	9	nC
Gate-Drain Charge ^c	Q_{gd}			-	8.5	13	
Gate Resistance	R_g	f = 1 MHz		0.8	1.7	3.7	Ω
Turn-On Delay Time ^c	t _{d(on)}				8	12	
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_L = 0.75 \Omega$ $I_D \cong 40 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		-	13	20	- ns
Turn-Off Delay Time ^c	t _{d(off)}			ı	22	33	
Fall Time ^c	t _f			1	9	14	
Source-Drain Diode Ratings and Chara	cteristics ^b						
Pulsed Current ^a	I _{SM}			1	-	160	Α
Forward Voltage	V_{SD}	I _F = 20 A, V _{GS} = 0		-	0.85	1.2	V

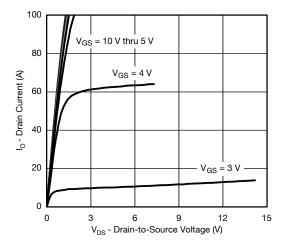
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

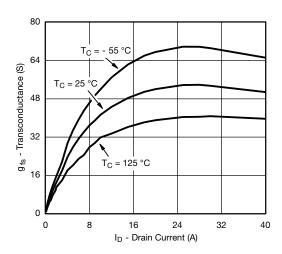
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



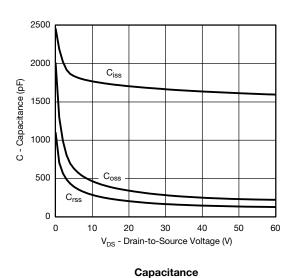
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

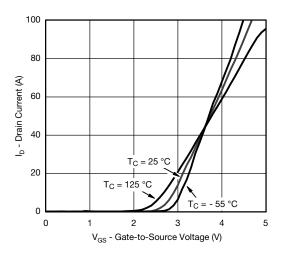


Output Characteristics

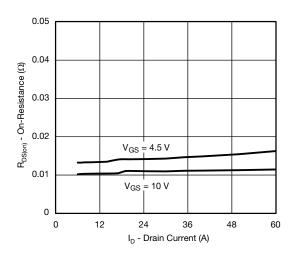


Transconductance

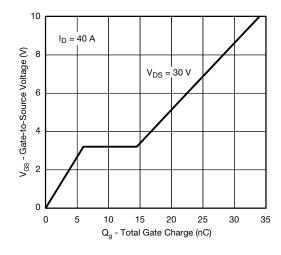




Transfer Characteristics



On-Resistance vs. Drain Current

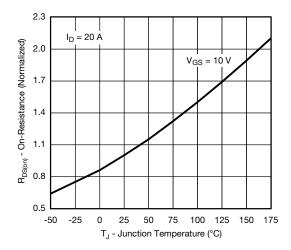


Gate Charge

1.2



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



0 0.2 0.4 0.6 0.8 1.0 V_{SD} - Source-to-Drain Voltage (V)

T_J = 150 °C

100

10

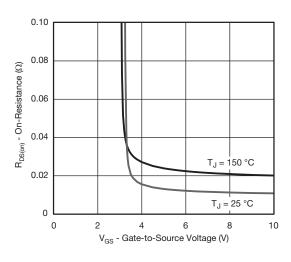
0.1

0.01

0.001

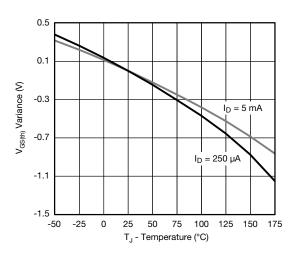
I_S - Source Current (A)



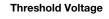


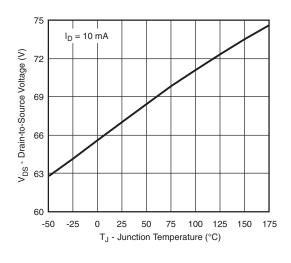
Source Drain Diode Forward Voltage

T_J = 25 °C



On-Resistance vs. Gate-to-Source Voltage

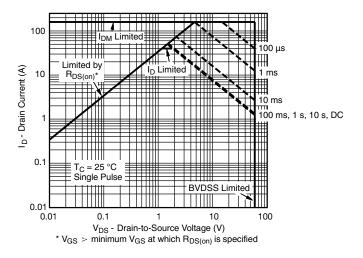




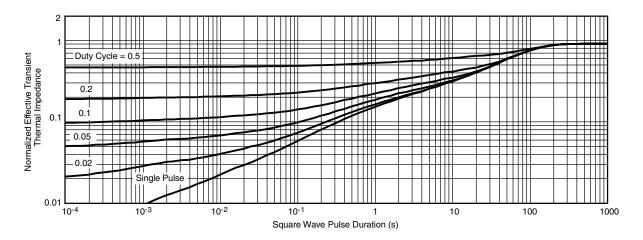
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



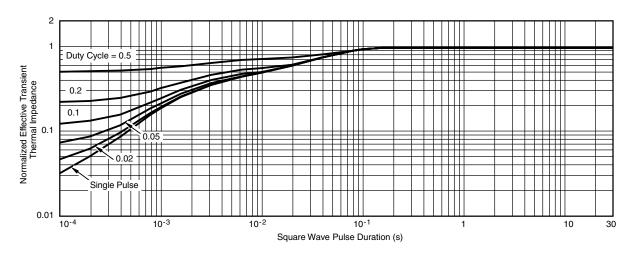
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg267002.



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REVISION HISTORY a				
REVISION	DATE	DESCRIPTION OF CHANGE		
С	04-Aug-15	Revised R _g minimum limit		

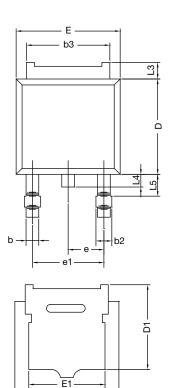
Note

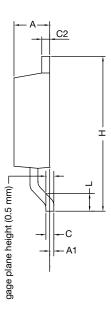
a. As of April 2014



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TO-252AA Case Outline





	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0592-Rev. A, 02-Sep-13 DWG: 6019					

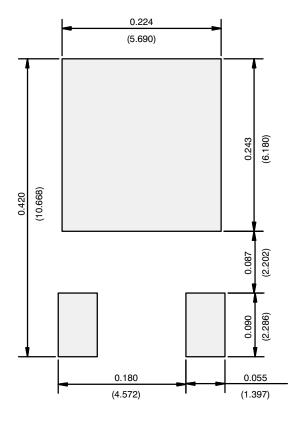
DWG: 6019

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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